## PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data    |                |   |
|----------------------|----------------|---|
| 1.1 Company          | life.augmented | STMicroelectronics International N.V  |
| 1.2 PCN No.          |                | MICROCONTROLLERS/25/15018   |
| 1.3 Title of PCN     |                | ASE Korea - BLUENRG-M2Sx Bluetooth® Low energy Modules - MCU and Capacitor component BOM enhancement. |
| 1.4 Product Category |                | BLUENRG-M2SA<br>BLUENRG-M2SP  |
| 1.5 Issue date       |                | 2025-04-25  |

| 2. PCN Team               |                     |  |
|---------------------------|---------------------|--|
| 2.1 Contact supplier      |                     |  |
| 2.1.1 Name                | PIKE EMMA           |  |
| 2.1.2 Phone               | +44 1628896111      |  |
| 2.1.3 Email               | emma.pike@st.com    |  |
| 2.2 Change responsibility |                     |  |
| 2.2.1 Product Manager     | Patrick AIDOUNE     |  |
| 2.1.2 Marketing Manager   | Veronique BARLATIER |  |
| 2.1.3 Quality Manager     | Pascal NARCHE       |  |

| 3. Change                |  |                            |
|--------------------------|--|----------------------------|
| 3.1 Category             | 3.2 Type of change   | 3.3 Manufacturing Location |
| General Product & Design | Product composition (lead frame finishing material / area (internal) | ASE (Korea)                |

| 4. Description of change  |  |   |  |
|---|--|---|--|
|   | Old  | New   |  |
| 4.1 Description   | BOM with: - (U1): BLUENRG-232(UTAC) in WFQFN (Wettable Flank) package - (C4 & C5): GRM0335C1H120GA01D 12pf capacitor | BOM with: - (U1): BLUENRG-232S (ST Calamba) MCU in QFN (Standard) package (for details refer to PCN14095 & PTN15181) - The Solder Resist Opening (SRO) of the Printed Circuit Board (PCB) has been updated to correspond to the Thermal Pad size of the Standard QFN - (C4 & C5): GJM0335C1E150GB01D 15pf capacitor |  |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | no impact  |   |  |

| 5. Reason / motivation for change |   |  |
|-----------------------------------|---|--|
| 5.1 Motivation                    | Product is still successful, business and Machine obsolescence. |  |
| 5.2 Customer Benefit              | SERVICE IMPROVEMENT   |  |

| 6. Marking of parts / traceability of change |   |
|--|---|
| 6.1 Description                              | Traceability ensured by ST Internal tools |

| 7. Timing / schedule                |              |  |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results   | 2025-06-16   |  |
| 7.2 Intended start of delivery      | 2025-07-21   |  |
| 7.3 Qualification sample available? | Upon Request |  |

| 8. Qualification / Validation |   |  |
|-------------------------------|---|--|
| 8.1 Description               | 15018 MDRF-GPAM-RER2508 PCN15018- ASEKR BLUENRG-M2Sx Modules - reliability plan.pdf |  |

|                       | Available (see attachment) | Issue | 2025-04-25 |
|-----------------------|----------------------------|-------|------------|
| qualification results |                            | Date  |            |

## 9. Attachments (additional documentations)

15018 Public product.pdf 15018 MDRF-GPAM-RER2508 PCN15018- ASEKR BLUENRG-M2Sx Modules - reliability plan.pdf 15018 \_Additional information.pdf

| 10. Affected parts                              |              |                          |  |
|---|--------------|--------------------------|--|
| 10. 1 Current                                   |              | 10.2 New (if applicable) |  |
| 10.1.1 Customer Part No 10.1.2 Supplier Part No |              | 10.1.2 Supplier Part No  |  |
|   | BLUENRG-M2SA |                          |  |
|   | BLUENRG-M2SP |                          |  |

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